

HLs	Search Text	DBs	Time Stamp	Count
1	"JP200020037A"	US-FGPIB; USPAT; EPO; JPO; DERMENT; IBM_IDS	2005/02/22 13:50	
2	"10/752503"	US-FGPIB; USPAT; EPO; JPO; DERMENT; IBM_IDS	2005/02/22 13:50	
3	((crench adj capacitor) and (doped adj polysilicon) and scrap) and (257/532,296,301,303,304,306,311.ccls. 438/238,239,386,399,243,386.ccls-.) and arsenic and phosphorus and @pds"20041020"	US-FGPIB; USPAT; EPO; JPO; DERMENT; IBM_IDS	2005/02/19 11:31	
4	59 510	US-FGPIB; USPAT; EPO; JPO; DERMENT; IBM_IDS	2005/02/19 11:31	
5	((crench adj capacitor) and (doped adj polysilicon) and scrap) and (257/532,296,301,303,304,306,311.ccls. 438/238,239,386,399,243,386.ccls-.) and (first wth polysilicon) and (second wth polysilicon))	US-FGPIB; USPAT; EPO; JPO; DERMENT; IBM_IDS	2005/02/19 11:30	
6	((crench adj capacitor) and (doped adj polysilicon) and scrap) and (257/532,296,301,303,304,306,311.ccls. 438/238,239,386,399,243,386.ccls-.) and arsenic and phosphorus	US-FGPIB; USPAT; EPO; JPO; DERMENT; IBM_IDS	2005/02/19 11:30	
7	((crench adj capacitor) and (doped adj polysilicon) and scrap) and (257/532,296,301,303,304,306,311.ccls. 438/238,239,386,399,243,386.ccls-.) and (first wth polysilicon) and (second wth polysilicon)) and @pds"20041020"	US-FGPIB; USPAT; EPO; JPO; DERMENT; IBM_IDS	2005/02/19 11:30	
8	((crench adj capacitor) and (doped adj polysilicon) and scrap) and (257/532,296,301,303,304,306,311.ccls. 438/238,239,386,399,243,386.ccls-.)	US-FGPIB; USPAT; EPO; JPO; DERMENT; IBM_IDS	2004/10/20 13:20	
9	(first wth polysilicon) and (second wth polysilicon)	US-FGPIB; USPAT; EPO; JPO; DERMENT; IBM_IDS	2004/10/20 12:44	
10	257/532,296,301,303,304,306,311.ccls. 438/238,239,386,399,243,386.ccls.	US-FGPIB; USPAT; EPO; JPO; DERMENT; IBM_IDS	2004/10/20 12:42	
11	(crench adj capacitor) and (doped adj polysilicon) and scrap	US-FGPIB; USPAT; EPO; JPO; DERMENT; IBM_IDS	2004/10/20 12:41	
12	("6200873" "5903279"). pn.	US-FGPIB; USPAT; EPO; JPO; DERMENT; IBM_IDS	2004/10/20 12:39	

Updated EAST search 2/22/05